

Bi-directional ESD Protection Array

Description

The H02C325V0BL is designed to protect sensitive electronics from damage or latch up due to ESD and other voltage induced transient events. The device will protect two line operating at 5.0 volts.

Features

Peak Pulse Power :Ppp = 28W (tp=8/20 us)

Reverse Working Voltage: 5V

Protects Two Data Lines

Low Clamping Voltage

• Low Capacitance: 3pF Typical (I/O-Gnd)

IEC 61000-4-2 (ESD) :±12kV(Contact) / ±18kV(Air)

Applications

- USB2.0 Power and data lines protection
- Digital Visual Interface (DVI)
- Notebook and PC Computers
- Video Graphics Cards

Peak Pulse Power - 28 Watts Reverse Working Voltage - 5.0V

Mechanical Data

- Case Material: "Green" Molding Compound UL Flammability Classification Rating 94V-0
- •Terminals:Matte tin plated, solderable per MIL-STD-750, method 2026
- Component in accordance to RoHS
- Halogen Free

Note: Products with logo for are made by HY Electronic (Cayman) Limited.

Ordering Information

- Package :SOT23
- Reel Size :7 (inches)
- •Quantity Per Reel :3,000 pcs
- Quantity One Box :45,000 pcs
- Quantity One Carton: 180,000 pcs

Marking Information



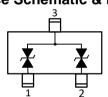
" 1UW " = Product Type Marking Code

Package Outline



SOT23 Top View

Device Schematic & PIN Configuration



Pin Assignment			
1, 2	Input lines		
3	Ground		

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Absolute Ratings

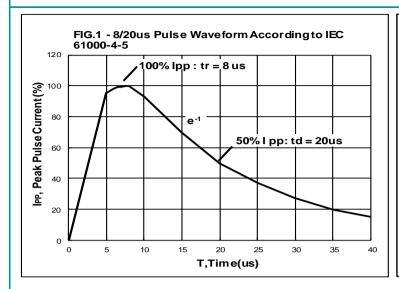
Parameter	Symbol	Value	Unit	
Peak Pulse Power Dissipation (8/20 us)	P _{PP}	28	W	
Peak Pulse Current (8/20 us)	lpp	2	Α	
ESD Protection- Contact (Standard IEC 61000-4-2)	Vesd	±12	k V	
ESD Protection- Air (Standard IEC 61000-4-2)	VESD	±18	r v	
Operating Temperature Range	TJ	-55 to +125	° C	
Storage Temperature Range	Тѕтс	-55 to +150	° C	

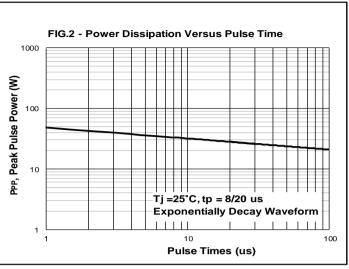
Electrical Characteristics

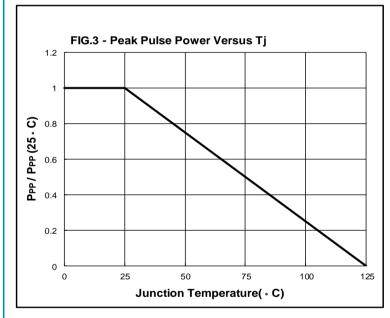
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
Reverse Working Voltage	Any I/O pin to ground	Vrwm	-	-	5	V
Reverse Breakdown Voltage	Iτ= 1mA Any I/O pin to ground	Vв	5.6	-	9.4	V
Reverse Current	$V_R = 5V$ Any I/O pin to ground	lr	-	-	1	uA
Reverse Clamping Voltage	I _{PP} = 1A (8/20µs) Any I/O pin to ground	- Vc	-	-	10.5	V
Reverse Clamping Voltage	IPP = 2A (8/20µs) Any I/O pin to ground		-	-	14	V
Junction Capacitance	V _R = 0V, F = 1MHz Any I/O pin to ground	Cj	-	3	4	рF

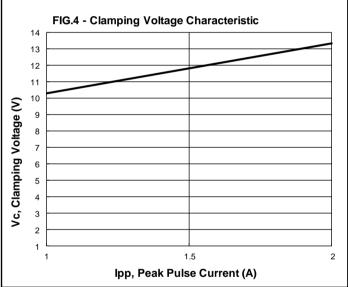


Rating and Characteristic Curves



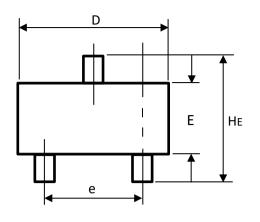


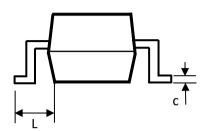




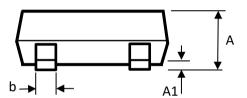


Package Outline Dimensions

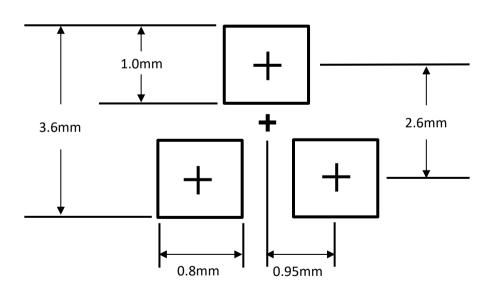




SOT23 Package				
Dim	Min	Max		
Α	0.89	1.11		
A1	0.01	0.10		
b	0.37	0.50		
С	0.09	0.18		
D	2.80	3.04		
Е	1.20	1.40		
е	1.78	2.04		
L	0.35	0.69		
HE	2.10	2.64		
All Dimensions in mm				



Suggested Soldering Pad Layout





Legal Disclaimer Notice

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